

Table I - Electrical Characteristics

Parameters	QT3003C	QT3013C	QT3023C	QT3003S	QT3013S	QT3023S
	(DIP)	(SMD)	(Gull Wing)	(DIP)	(SMD)	(Gull Wing)
Output freq. range (Fo)	10MHz — 80MHz					
Supply voltage (Vdd)	+3.3Vdc ± 5% or +5Vdc ± 5%					
Maximum Applied Voltage (Vdd max.)	+6.5Vdc					
Frequency stability (ΔF/ΔT)	See Option codes					
Operating temp. (Topr)	See Option codes					
Storage temp. (Tsto)	-62°C to + 125°C					
Operating supply current (Idd)	20mA (No Load) at 3.3Vdc 40mA (No Load) at 5.0Vdc					
Output amplitude or power	High (min.): Vcc - 10% Low (max.): Gnd + 10%		3dBm ± 3dBm			
Output Load	10k/1.5pF		50Ω			
Total Harmonic Distortion (THD) or harmonics	N/A		-20dBc max.			
Sub-harmonics	-40dBc max.					
Start-up time	10ms max.					
Phase Noise at 25°C (yp.) at 80MHz	10Hz		-70dBc/Hz			
	100Hz		-100dBc/Hz			
	1KHz		-130dBc/Hz			
	10KHz		-150dBc/Hz			
Integrated Phase Jitter RMS (12KHz to 20MHz) typ.	100KHz		-155dBc/Hz			
	1ps					
Aging (at 70°C)	± 5ppm max. 10 years					

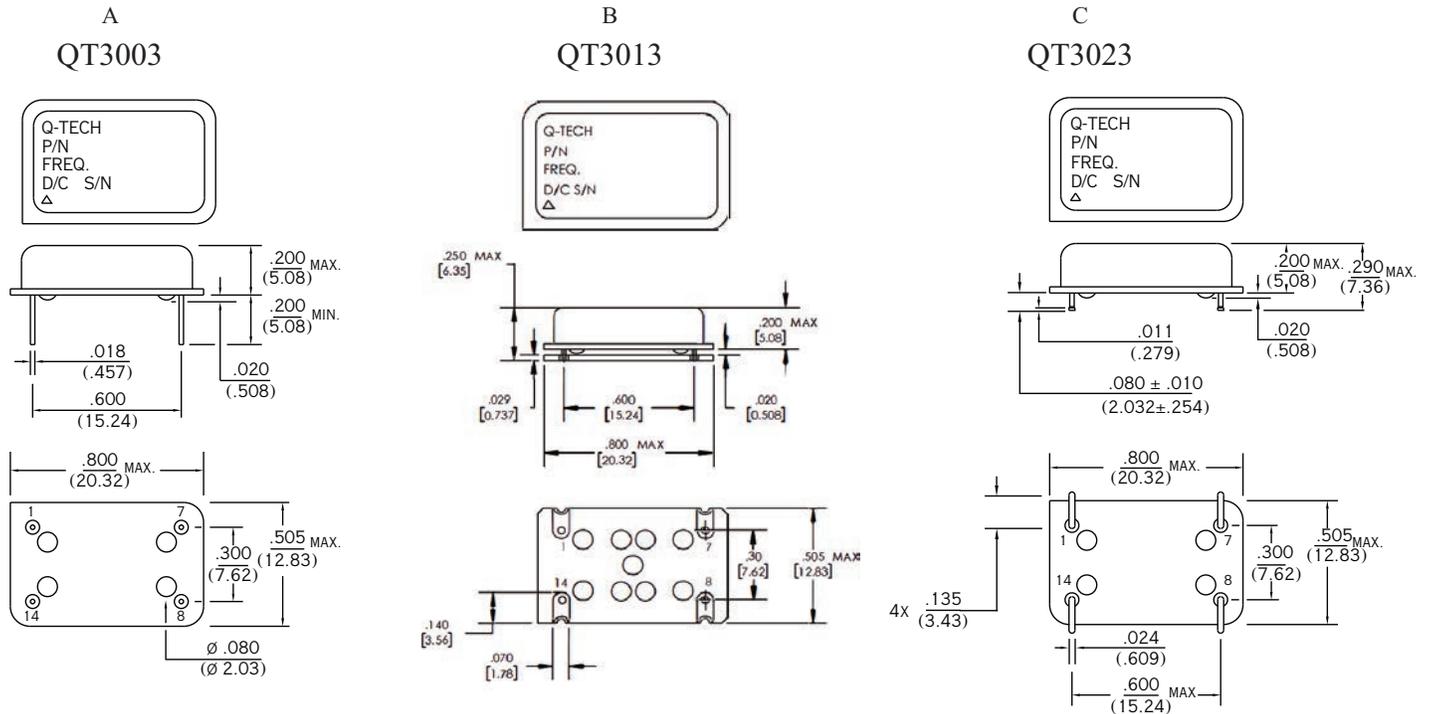
Other Design and Test Options

- Supply voltage +3.3Vdc to +5Vdc
- Output power -10dBm to +13dBm into 50Ω (see note 1)
- Harmonics better than -20dBc (see note 2)
- Sub-harmonics better than -30dBc (see note 3)
- Amplitude stability versus temperature to within ±1% (see note 4)
- Phase Noise and Jitter built to specification including static and vibration.
- Low supply current
- QCI tests
- Tight frequency stability versus temperature, supply voltage, and load variations
- Low g-sensitivity and low phase noise
- Low spurious (see note 5)
- Low Harmonic Distortion (THD < 5%)
- Low frequency aging, Allan Variance
- High-shock resistant

Notes:

1. The output level is determined by the supply voltage, load, and package size.
2. A specified harmonic level of -20dBc is easily achievable. The typical harmonics of Q-Tech Sine Wave source are better than -25dBc.
3. Sub-harmonic level is determined by frequency multiplication method, supply voltage, output power, and input current.
4. Typical amplitude stability over temperature is ±10% or less.
5. Typical spurious level is better than -90dBc over the spectrum of 100KHz to 1GHz.

Package Outline and Pin Connections
Dimensions are in inches (mm)

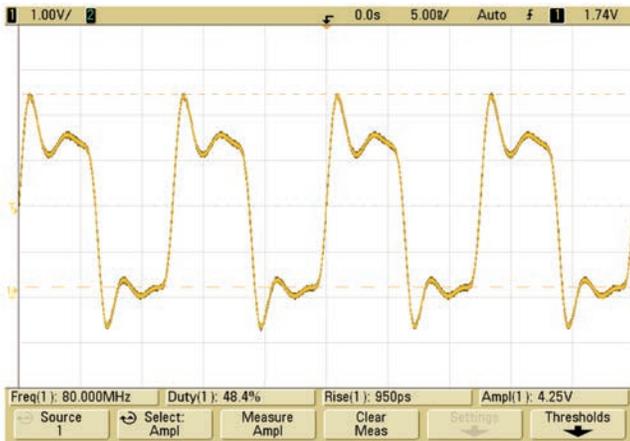


QT #	Conf	Vcc	GND	Case	Output	Equivalent MIL-PRF-55310 Configuration
QT3003	A	14	7	7	8	N/A
QT3013	B					
QT3023	C					

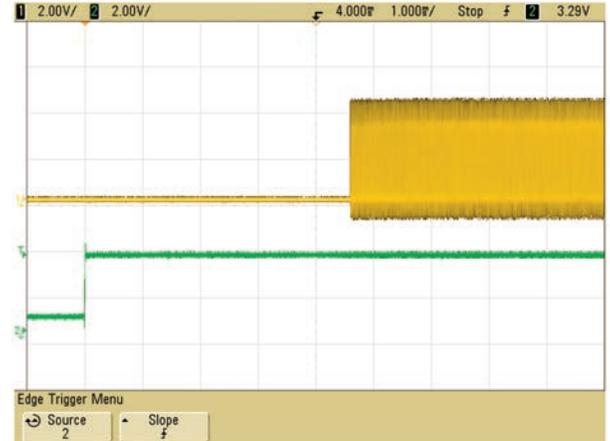
Package Information

- Package Material: Kovar, Nickel Plated
- PCB: FR4 (QT3013)
- Package to PCB Attachment: Solder Sn60
- Package to Lid Attachment: Resistance Weld
- Weight: 4.0g typ., 14.2g max.

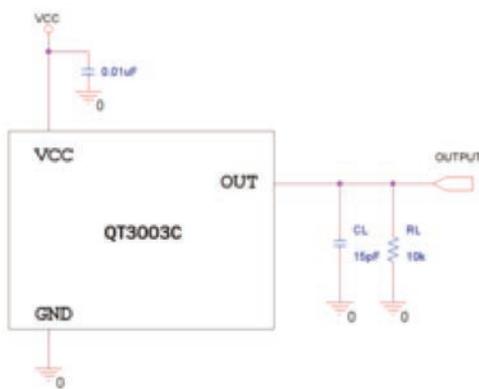
Output Waveform into HCMOS load



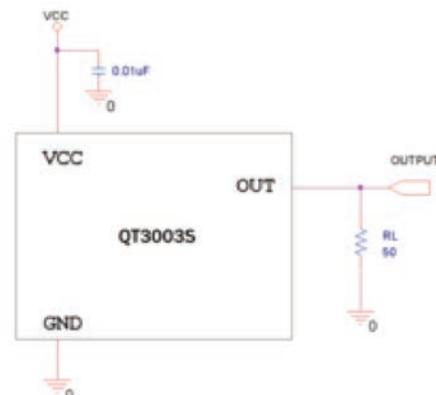
Startup Time



Test Circuit

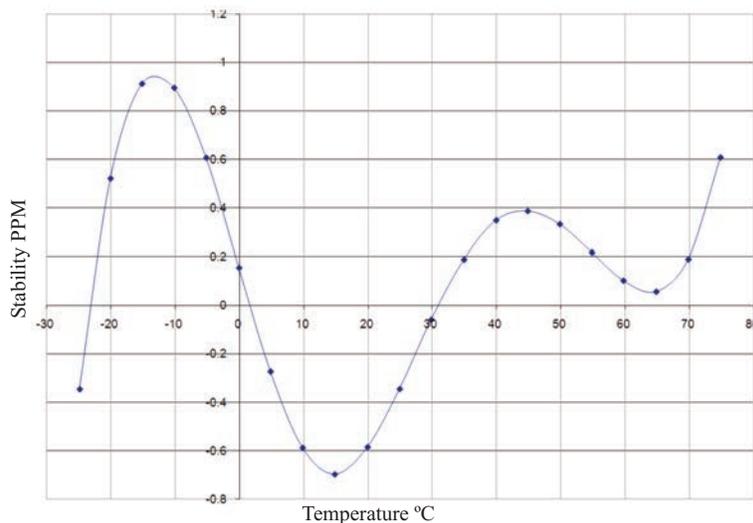


HCMOS Load



Sine Wave Load

Frequency vs. Temperature Curve



Typical Stability of QT3013C-80.000MHz

Table II - Screening and Testing

STEP	TEST (100% Unless Otherwise Specified)	CONDITION
1	Internal Visual	IPC-A-610/J-001 CLASS 1
2	Pre Burn-In Electrical Test	See Table I (optional)
3	Burn-In	MIL-PRF-55310 160 Hours @ 125°C
4	Post Burn-In Electrical Test	See Table Parameters I
5	Aging	30 Days @70°C (Note: Can be reduced to 15 Days for units that are two times (2X) better than the specified aging tolerance and the aging curve is monolithic)
6	Thermal Shock	MIL-STD-202, Method 107, Condition A1
7	Post Thermal Shock Electrical Test	See Table I
8	Seal; Fine Leak	MIL-STD-883, Method 1014, Condition A1
9	Seal; Gross Leak	MIL-STD-883, Method 1014, Condition C
10	Final Electrical Test (Includes Phase Noise)	See Table I
11	Group A Inspection (Subgroup 1 Only)	MIL-PRF-55310
12	External Visual Inspection	MIL-STD-883, Method 2009

Table III - Environmental Specifications

Q-Tech Standard Screening similar to (MIL-PRF55310) is available. Q-Tech can also customize screening and test procedures to meet your specific requirements. The packages are designed and processed to exceed the following test conditions:

Environmental Test	Test Conditions
Temperature cycling	MIL-STD-883, Method 1010, Cond. B
Constant acceleration	MIL-STD-883, Method 2001, Cond. A, Y1
Seal Fine Leak	MIL-STD-883, Method 1014, Cond. A1
Burn-in	160 hours, 125°C with load
Aging	30 days, 70°C
Vibration sinusoidal	MIL-STD-202, Method 204, Cond. D
Shock, non operating	MIL-STD-202, Method 213, Cond. I
Thermal shock, non operating	MIL-STD-202, Method 107, Cond. B
Ambient pressure, non operating	MIL-STD-202, 105, Cond. C, 5 minutes dwell time minimum
Resistance to solder heat	MIL-STD-202, Method 210, Cond. C
Moisture resistance	MIL-STD-202, Method 106
Terminal strength	MIL-STD-202, Method 211, Cond. C
Resistance to solvents	MIL-STD-202, Method 215
Solderability	MIL-STD-202, Method 208
ESD Classification	MIL-STD-883, Method 3015, Class 1HBM 0 to 1,999V
Moisture Sensitivity Level	J-STD-020, MSL=1

Please contact Q-Tech for higher shock requirements

Phase Noise and Phase Jitter Integration

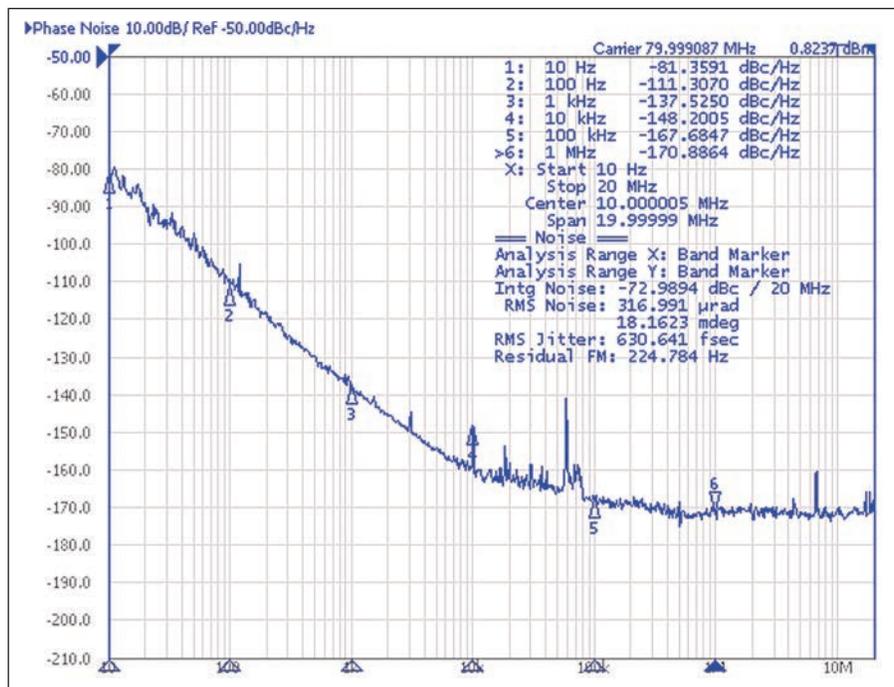
Phase noise is measured in the frequency domain, and is expressed as a ratio of signal power to noise power measured in a 1Hz bandwidth at an offset frequency from the carrier, e.g. 10Hz, 100Hz, 1kHz, 10kHz, 100kHz, etc. Phase noise measurement is made with an Agilent E5052A Signal Source Analyzer (SSA) with built-in outstanding low-noise DC power supply source. The DC source is floated from the ground and isolated from external noise to ensure accuracy and repeatability.

In order to determine the total noise power over a certain frequency range (bandwidth), the time domain must be analyzed in the frequency domain, and then reconstructed in the time domain into an RMS value with the unwanted frequencies excluded. This may be done by converting $L(f)$ back to $S_{\phi}(f)$ over the bandwidth of interest, integrating and performing some calculations.

Symbol	Definition
$\int L(f)$	Integrated single side band phase noise (dBc)
$S_{\phi}(f) = (180/\pi) \times \sqrt{2} \int L(f) df$	Spectral density of phase modulation, also known as RMS phase error (in degrees)
RMS jitter = $S_{\phi}(f) / (f_{osc} \cdot 360^\circ)$	Jitter (in seconds) due to phase noise. Note $S_{\phi}(f)$ in degrees.

The value of RMS jitter over the bandwidth of interest, e.g. 10kHz to 20MHz, 10Hz to 20MHz, represents 1 standard deviation of phase jitter contributed by the noise in that defined bandwidth.

Figure below shows a typical Phase Noise/Phase Jitter of a QT3013C, 3.3Vdc, 80.000MHz TCXO at offset frequencies 10Hz to 1MHz, and phase jitter integrated over the bandwidth of 10Hz to 20MHz.





ANALOG TCXO
DUAL-IN-LINE CRYSTAL OSCILLATORS
3.3 to 5Vdc - 10MHz to 80MHz

DCO	REV	REVISION SUMMARY	PAGE	DATE
6802	-	Initial Release renamed from Analog TCXO (Revision D, December 2011) (ECO# 10367)	All	5/16/2017
		Add Solder Dip (S) option in Ordering Information	1	
		Update QT3013 Outline	3	
6997	A	Add lead length to QT3023 Outline	3	7/14/2017
7984	B	Clarify 'M' screening option: Re-word option 'M' in ordering information; Add note (***) Add Screening and Testing flow (Table II)	1 5	3/22/2018
		Move Frequency vs Temperature curve from Page 5 to Page 4	4, 5	
		Assign numbers to tables (Electrical Characteristics and Environmental Specifications)	2, 5	